

Features

- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant(Note 1) ("P" Suffix Designates Compliant. See Ordering Information)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Low Switching Losses and High Efficiency
- Low Reverse Leakage
- Ultrafast Recovery Time
- Planar Structure Die and Soft Recovery Characteristics

20 Amp FRED Rectifiers 600 Volts

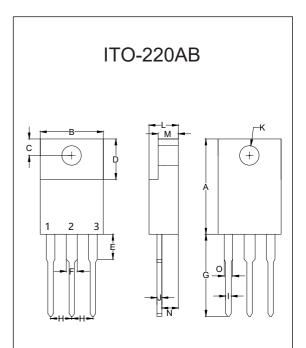
Maximum Ratings @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V _{RWM}	600	V
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{RMS}	420	V
Average Rectified Forward Current			
Per Diode Per Device	I _{F(AV)}	10 20	А
Non-Repetitive Peak Surge Current @8.3ms Half Sine Wave	I _{FSM}	120	А
Current Squared Time @ 1ms≤t≤8.3ms	l ² t	59.76	A ² s

Internal Structure

Pin	Description	Simplified Outline	Graphic Symbol
2	Cathode		
1&3	Anode	MCC.	1 0
		MURS2060FCTA	3 0 2

Note: 1. High Temperature Solder Exemption Applied, See EU Directive Annex 7a.



	DIMENSIONS						
DIM	INCHES		MM		NOTE		
Diivi	MIN	MAX	MIN	MAX	INOIL		
Α	0.567	0.642	14.40	16.30			
В		0.421		10.70			
С	0.085	0.128	2.15	3.25			
D	0.248	0.272	6.30	6.90			
E		0.177		4.50			
F		0.071		1.80			
G	0.500	0.539	12.70	14.20			
Н	0.100		2.55				
I		0.035		0.90			
J		0.032		0.80			
K	0.102	0.150	2.60	3.80	Ф		
L		0.201		5.10			
М		0.140		3.56			
N	0.083	0.126	2.10	3.20			
0		0.071		1.80			



Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TJ	Operating Junction Temperature Range		-55		175	°C
T _{stg}	Storage Temperature Range		-55		175	°C
Rth _(J-C)	Thermal Resistance from Junction to Case			4		°C/W

Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage	V _F	I _F =10A;T _J =25°C		1.40	1.60	V
		I _F =10A;T _J =150°C		1.18	1.30	V
Reverse Current	I _R	V _R =600V;T _J =25°C			5	uA
		V _R =600V;T _J =150°C			200	uA
Junction Capacitance	CJ	V _R =4V;f=1MHz;T _J =25°C		45		pF

Dynamic Recovery Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
	I _F =0.5A; I _R =1.0A;I _{RR} =0.25A;		5A;T _J =25°C		20	35	
Reverse Recovery Time	t _{rr}		T _J =25°C		102		ns
		I _F =10A d _{iF} /d _t =-200A/μs V _{RM} =400V	T _J =150°C		152		
Peak Recovery Current I _{RRM}			T _J =25°C		3.52		^
	IRRM		T _J =150°C		8.18		Α
Reverse Recovery Charge Q _{rr}	0		T _J =25°C		180		nC
	Q _{rr}		T _J =150°C		623		IIC



0.0

0.4

Curve Characteristics

Fig. 1 - Forward Current Derating Curve 24 20 Average Forward Current (A) Resistive or Inductive Load 25 50 75 100 125 150 175 Case Temperature (°C)

Fig. 3 - Typical Forward Characteristics 30 10 T₁= -40°C Forward Current (A) =25°C =100°C =125°C =150°C 0.1

Forward Voltage (V)

Fig. 5 - Typical Capacitance Characteristics 1000 T_J=25°C f=1MHz Junction Capacitance (pF) 0.1 600 10 100 Reverse Voltage (V)

150 8.3 ms Single Half Sine-Wave

Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

100 Number of Cycles at 60 Hz

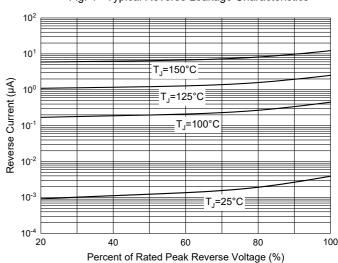
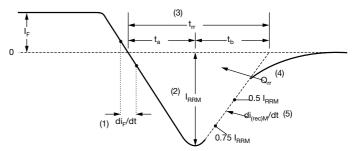


Fig. 4 - Typical Reverse Leakage Characteristics

Fig. 6 - Reverse Recovery Waveform and Definitions



- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.
- (4) Q_{rr} area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}



Ordering Information

Device	Packing				
Part Number-BP	Bulk:50pcs/Tube,1Kpcs/Box,5Kpcs/Carton				

Note: Adding "-HF" Suffix For Halogen Free, eg. Part Number-BP-HF

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